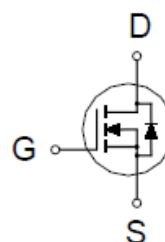
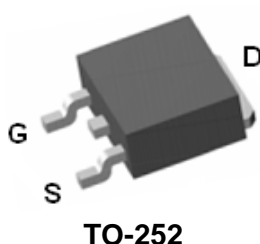


# P5015BD

## N-Channel Enhancement Mode MOSFET

### PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
150V	50mΩ @ $V_{GS} = 10V$	24A



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ }^{\circ}\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	150	V
Gate-Source Voltage		$V_{GS}$	±20	
Continuous Drain Current <sup>1</sup>	$T_C = 25\text{ }^{\circ}\text{C}$	$I_D$	24	A
	$T_C = 100\text{ }^{\circ}\text{C}$		15	
Pulsed Drain Current <sup>2</sup>		$I_{DM}$	90	
Avalanche Current		$I_{AS}$	19	
Avalanche Energy	$L=0.1\text{mH}$	$E_{AS}$	18	mJ
Power Dissipation	$T_C = 25\text{ }^{\circ}\text{C}$	$P_D$	78	W
	$T_C = 100\text{ }^{\circ}\text{C}$		31	
Junction & Storage Temperature Range		$T_J, T_{STG}$	-55 to 150	$^{\circ}\text{C}$

### THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		1.6	$^{\circ}\text{C} / \text{W}$
Junction-to-Ambient	$R_{\theta JA}$		62.5	

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Limited by package.

# P5015BD

## N-Channel Enhancement Mode MOSFET

### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	150			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	1.5	2.1	4	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V			±250	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 120V, V <sub>GS</sub> = 0V			1	μA
		V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V , T <sub>J</sub> = 125°C			10	
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 4A		47	90	mΩ
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		40	50	
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 20A		36		S
DYNAMIC						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz		4658		pF
Output Capacitance	C <sub>oss</sub>			172		
Reverse Transfer Capacitance	C <sub>rss</sub>			123		
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f =1MHz		2.5		Ω
Total Gate Charge <sup>2</sup>	Q <sub>g</sub>	V <sub>DS</sub> = 75V, V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A		88.4		nC
Gate-Source Charge <sup>2</sup>	Q <sub>gs</sub>			18.1		
Gate-Drain Charge <sup>2</sup>	Q <sub>gd</sub>			27.2		
Turn-On Delay Time <sup>2</sup>	t <sub>d(on)</sub>	V <sub>DS</sub> = 75V, I <sub>D</sub> ≅ 20A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω		35		nS
Rise Time <sup>2</sup>	t <sub>r</sub>			225		
Turn-Off Delay Time <sup>2</sup>	t <sub>d(off)</sub>			175		
Fall Time <sup>2</sup>	t <sub>f</sub>			210		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T <sub>J</sub> = 25 °C)						
Continuous Current	I <sub>S</sub>				24	A
Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>F</sub> = 20A, V <sub>GS</sub> = 0V			1.4	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 20A, dI <sub>F</sub> /dt=100A/μS		69		nS
Reverse Recovery Charge	Q <sub>rr</sub>			208		nC

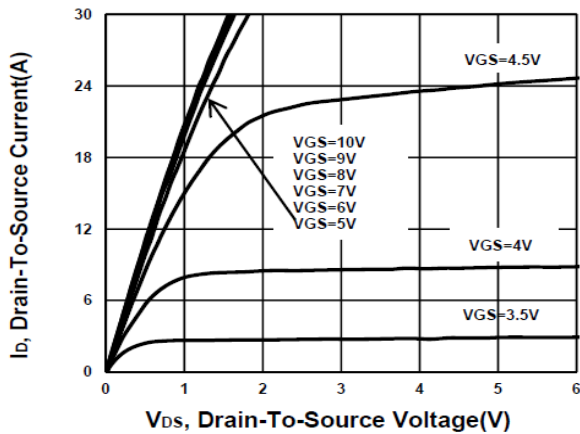
<sup>1</sup> Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup> Independent of operating temperature.

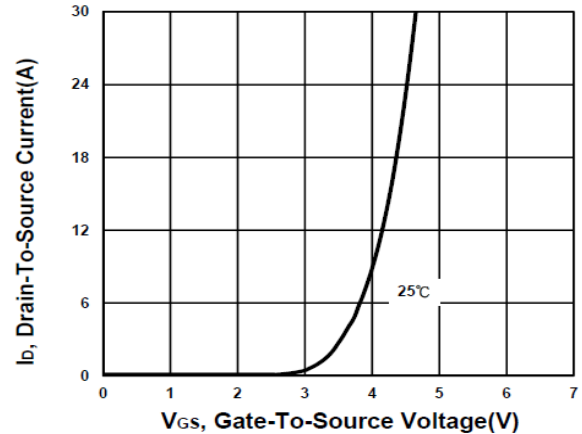
## P5015BD

### N-Channel Enhancement Mode MOSFET

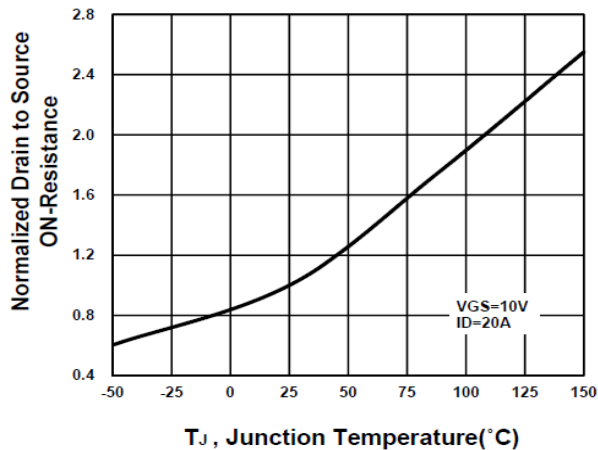
**Output Characteristics**



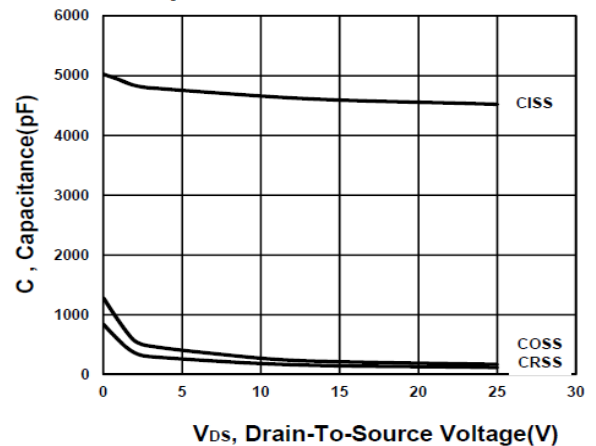
**Transfer Characteristics**



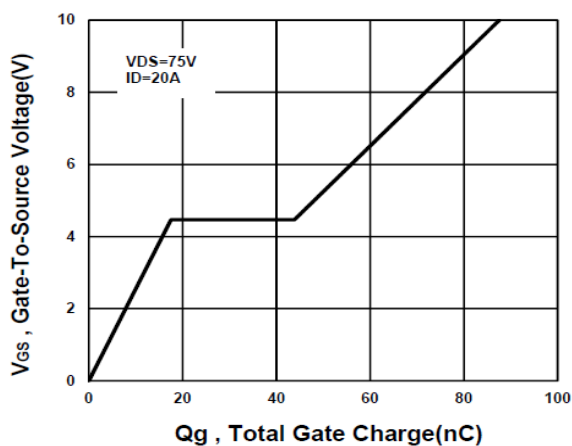
**On-Resistance VS Temperature**



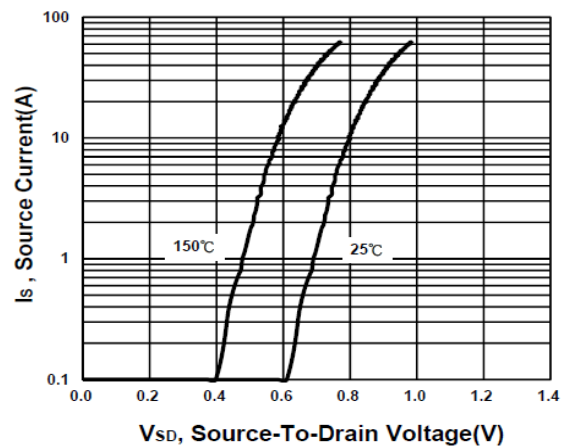
**Capacitance Characteristic**



**Gate charge Characteristics**



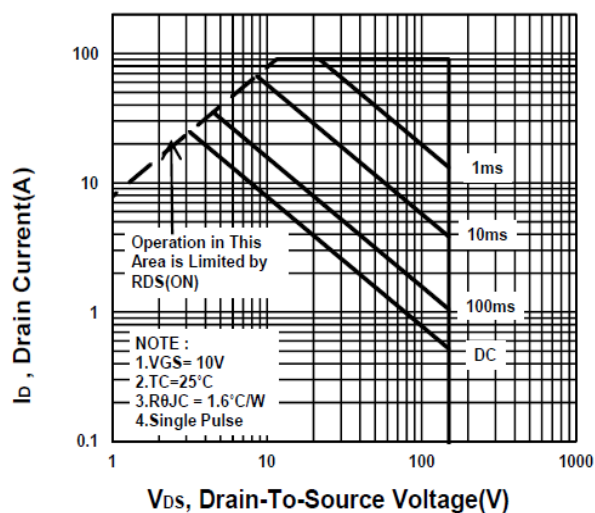
**Source-Drain Diode Forward Voltage**



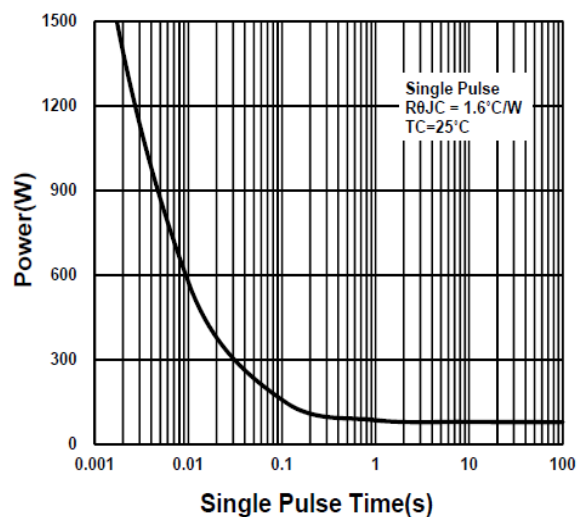
# P5015BD

## N-Channel Enhancement Mode MOSFET

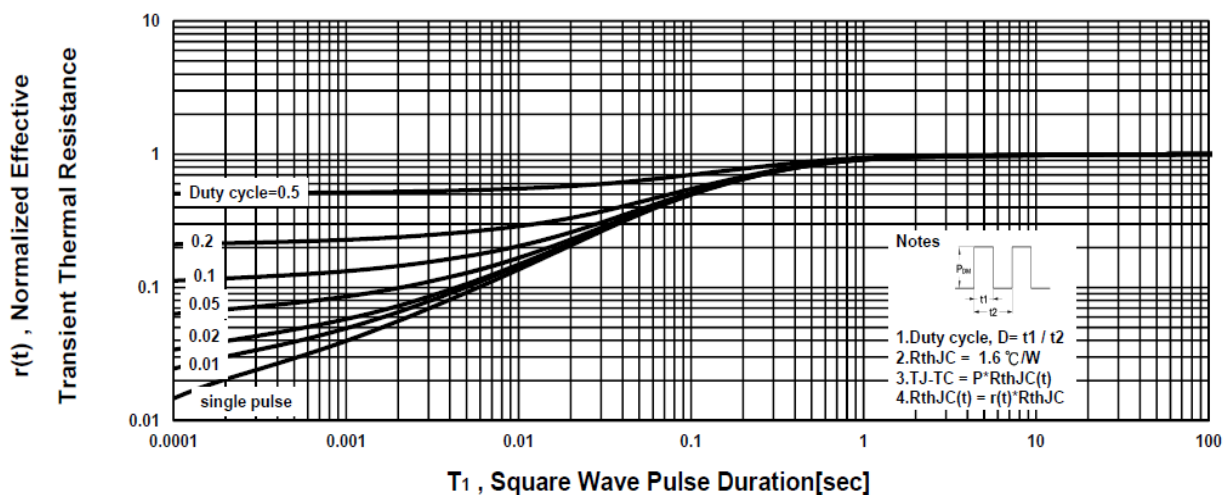
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**



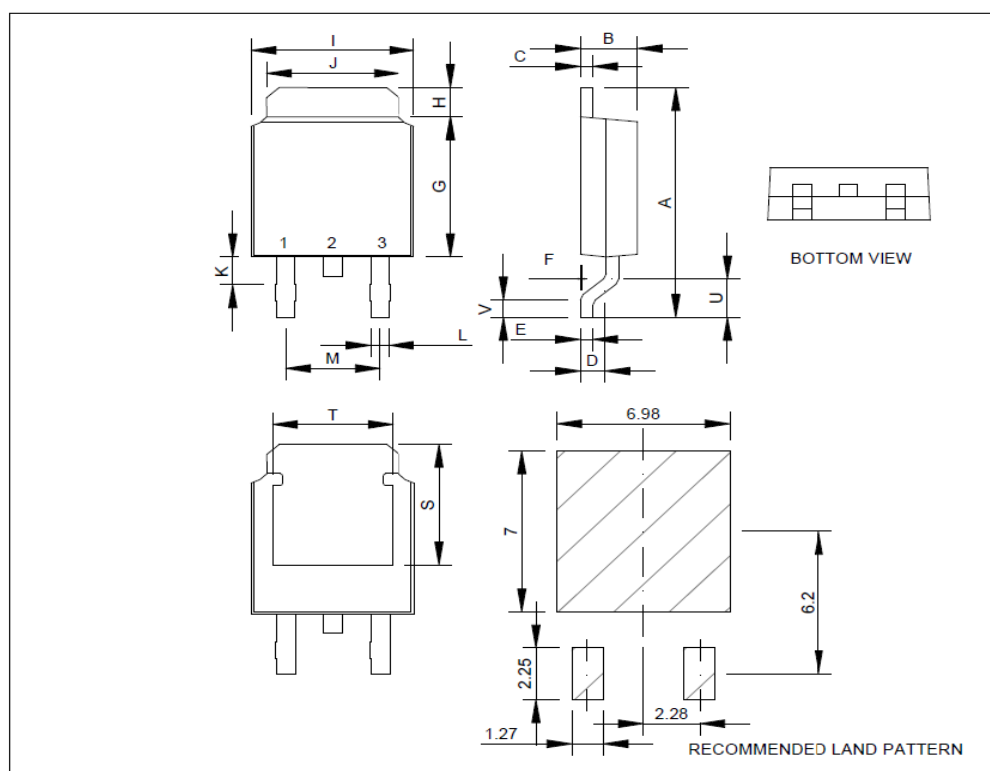
# P5015BD

## N-Channel Enhancement Mode MOSFET

### Package Dimension

### TO-252 (DPAK) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	8.9	10	10.41	J	4.8		5.64
B	2.1	2.2	2.4	K	0.15		1.1
C	0.4	0.5	0.61	L	0.4	0.76	0.89
D	0.82	1.2	1.5	M	4.2	4.58	5
E	0.4	0.5	0.61	S	4.9	5.1	5.3
F	0		0.2	T	4.6	4.75	5.44
G	5.3	6.1	6.3	U	1.4		1.78
H	0.9		1.7	V	0.55	1.25	1.7
I	6.3	6.5	6.8				



\*因为各家封装模具不同而外观略有所差异，不影响电性及Layout。